

Sonic Fast Recovery Diode

V_{RRM} = 1800V
 I_{FAV} = 2x 60A
 t_{rr} = 230ns

High Performance Fast Recovery Diode

Low Loss and Soft Recovery

Parallel legs

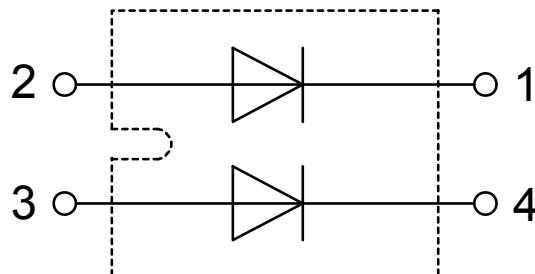
Part number

DH2x61-18A



Backside: Isolated

E72873



Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low I_{rm} -values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low I_{rm} reduces:
 - Power dissipation within the diode
 - Turn-on loss in the commutating switch

Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

Package: SOT-227B (minibloc)

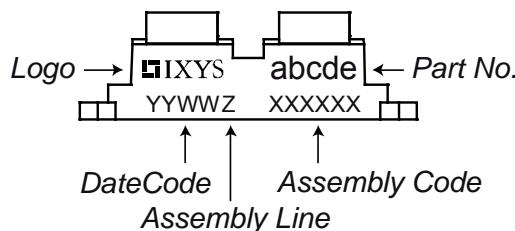
- Isolation Voltage: 3000V~
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Base plate: Copper internally DCB isolated
- Advanced power cycling

Fast Diode

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
V_{RSM}	max. non-repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			1800	V
V_{RRM}	max. repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			1800	V
I_R	reverse current, drain current	$V_R = 1800 V$ $V_R = 1800 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		200 2	μA mA
V_F	forward voltage drop	$I_F = 60 A$ $I_F = 120 A$ $I_F = 60 A$ $I_F = 120 A$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		2.01 2.51 2.02 2.71	V V V V
I_{FAV}	average forward current	$T_C = 55^\circ C$ rectangular $d = 0.5$	$T_{VJ} = 150^\circ C$		60	A
V_{F0} r_F	threshold voltage slope resistance } for power loss calculation only		$T_{VJ} = 150^\circ C$		1.28 11.1	V $m\Omega$
R_{thJC}	thermal resistance junction to case				0.6	K/W
R_{thCH}	thermal resistance case to heatsink			0.10		K/W
P_{tot}	total power dissipation		$T_C = 25^\circ C$		200	W
I_{FSM}	max. forward surge current	$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}; V_R = 0 V$	$T_{VJ} = 45^\circ C$		700	A
C_J	junction capacitance	$V_R = +03 V$ $f = 1 \text{ MHz}$	$T_{VJ} = 25^\circ C$		32	pF
I_{RM}	max. reverse recovery current		$T_{VJ} = 25^\circ C$ $T_{VJ} = 100^\circ C$		60 70	A A
t_{rr}	reverse recovery time	$I_F = 60 A; V_R = 1200 V$ $-di_F/dt = 800 A/\mu s$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 100^\circ C$		230 350	ns ns

Package SOT-227B (minibloc)			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal			100	A
T_{stg}	storage temperature		-40		150	°C
T_{VJ}	virtual junction temperature		-40		150	°C
Weight				30		g
M_D	mounting torque		1.1		1.5	Nm
M_T	terminal torque		1.1		1.5	Nm
V_{ISOL}	isolation voltage	t = 1 second t = 1 minute 50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA	3000 2500			V V
$d_{Spp/App}$	creepage distance on surface / striking distance through air		terminal to terminal	10.5	3.2	mm
$d_{Spb/Abp}$			terminal to backside	8.6	6.8	mm

Product Marking



Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DH2x61-18A	DH2x61-18A	Tube	10	500860

Similar Part	Package	Voltage class
DH2x60-18A	SOT-227B (minibloc)	1800
DH2x61-16A	SOT-227B (minibloc)	1600

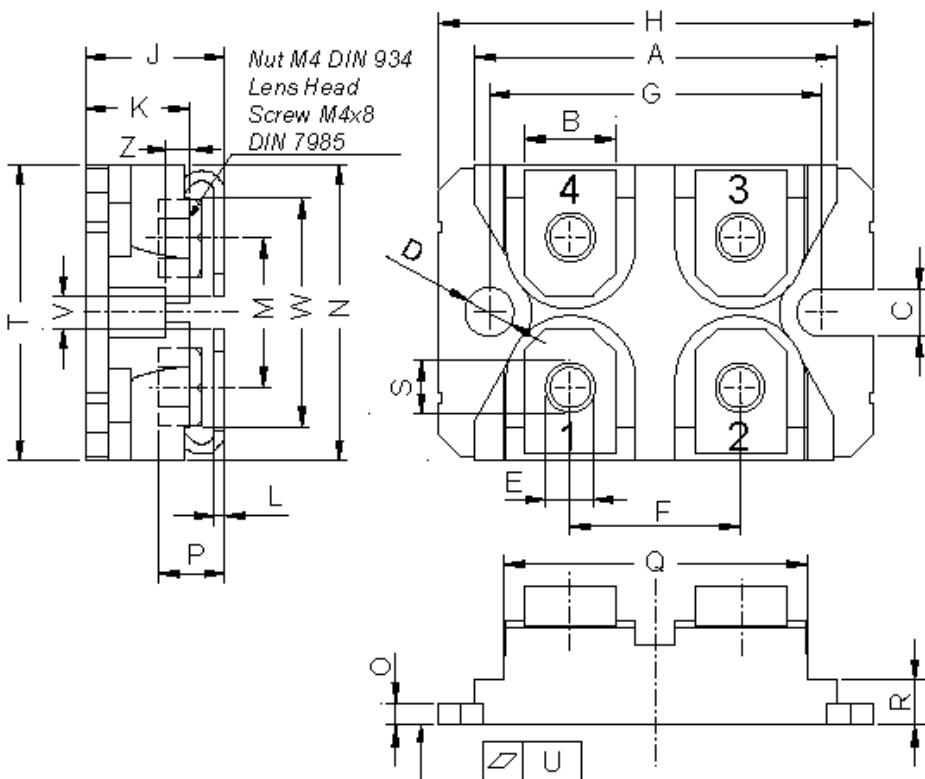
Equivalent Circuits for Simulation

* on die level

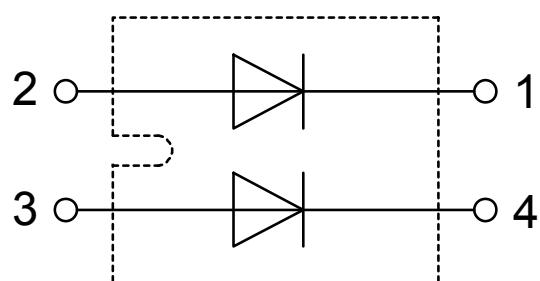
 $T_{VJ} = 150^\circ\text{C}$

I	V_0	R_0	Fast Diode	
$V_{0\max}$	threshold voltage	1.28		V
$R_{0\max}$	slope resistance *	9.3		$\text{m}\Omega$

Outlines SOT-227B (minibloc)



Dim.	Millimeter		Inches	
	min	max	min	max
A	31.50	31.88	1.240	1.255
B	7.80	8.20	0.307	0.323
C	4.09	4.29	0.161	0.169
D	4.09	4.29	0.161	0.169
E	4.09	4.29	0.161	0.169
F	14.91	15.11	0.587	0.595
G	30.12	30.30	1.186	1.193
H	37.80	38.23	1.488	1.505
J	11.68	12.22	0.460	0.481
K	8.92	9.60	0.351	0.378
L	0.74	0.84	0.029	0.033
M	12.50	13.10	0.492	0.516
N	25.15	25.42	0.990	1.001
O	1.95	2.13	0.077	0.084
P	4.95	6.20	0.195	0.244
Q	26.54	26.90	1.045	1.059
R	3.94	4.42	0.155	0.167
S	4.55	4.85	0.179	0.191
T	24.59	25.25	0.968	0.994
U	-0.05	0.10	-0.002	0.004
V	3.20	5.50	0.126	0.217
W	19.81	21.08	0.780	0.830
Z	2.50	2.70	0.098	0.106



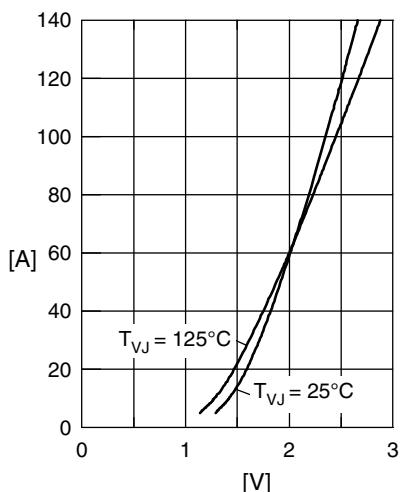
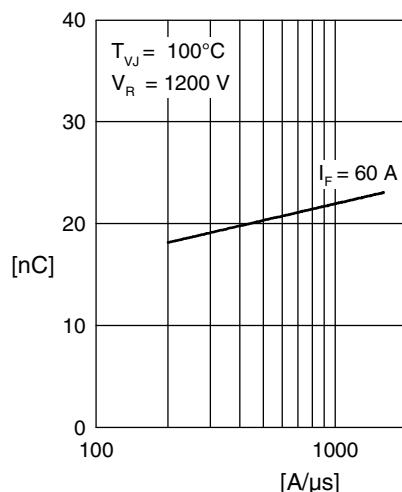
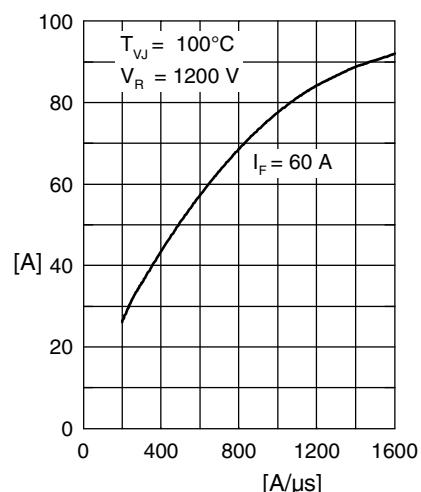
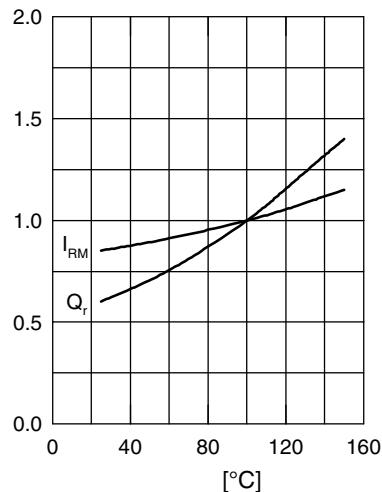
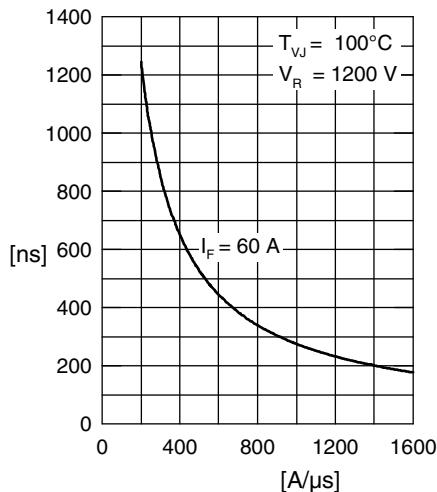
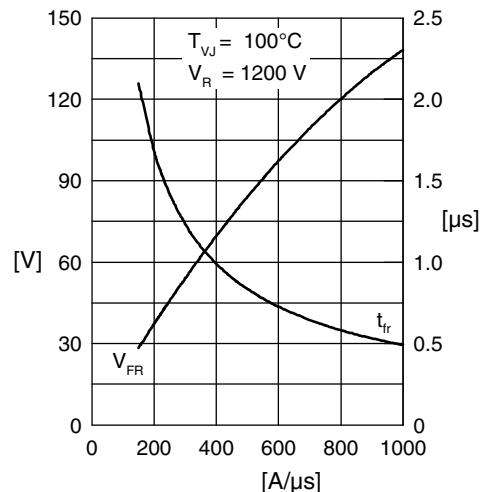
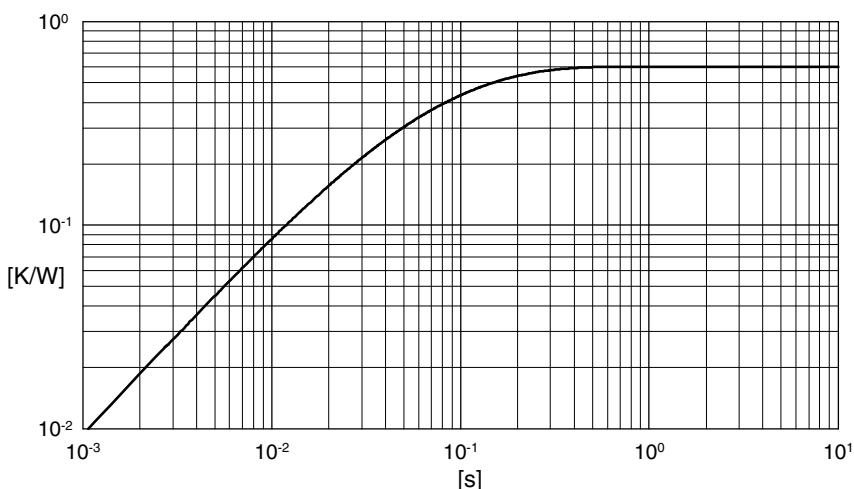
Fast DiodeFig. 1 Typ. forward current I_F versus V_F Fig. 2 Typ. reverse recovery charge Q_r versus $-di_F/dt$ Fig. 3 Typ. peak reverse current I_{RM} versus $-di_F/dt$ Fig. 4 Dynamic parameters Q_r , I_{RM} versus T_{VJ} Fig. 5 Typ. recovery time t_{rr} versus $-di_F/dt$ Fig. 6 Typ. peak forward voltage V_{FR} & typ. forward recovery time t_{fr} versus di_F/dt 

Fig. 7 Transient thermal resistance junction to case

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.212	0.0055
2	0.248	0.0092
3	0.063	0.0007
4	0.077	0.0391